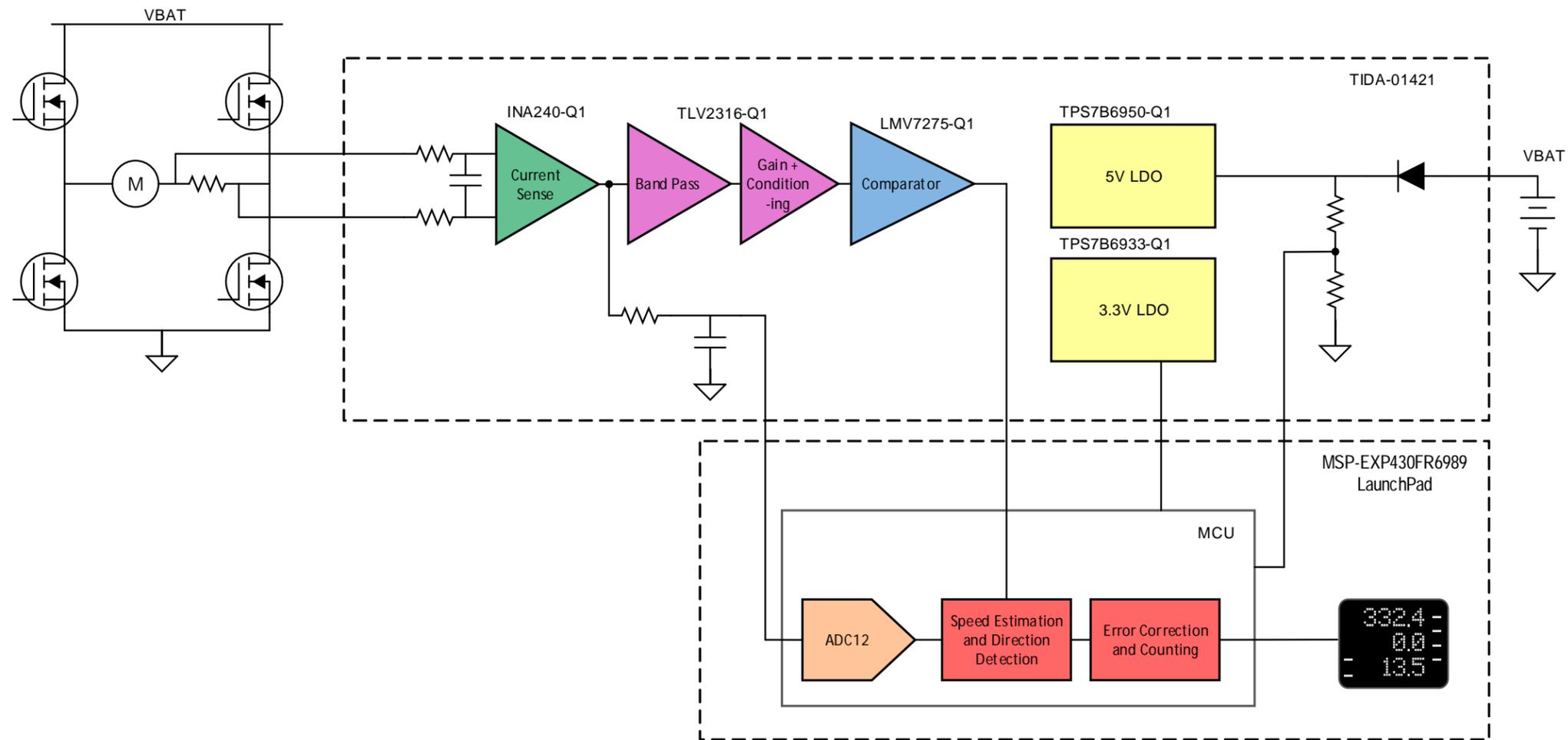


Revision History				
Rev	ECN #	Approved Date	Approved by	Notes
E1	N/A	N/A	N/A	N/A



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TID #: TIDA-01421	Project Title: DC Motor Ripple Counter		
Number: TIDA-01421	Rev: E1	Sheet: 1 of 3	
SVN Rev: Version control disabled	Assembly Variant: 001	Size: B	
Drawn By: Matt Sullivan	File: TIDA-01421 Block Diagram.SchDoc	Contact: http://www.ti.com/support	

PCB Number: TIDA-01421
PCB Rev: E1

PCB
LOGO
Pb-Free Symbol

PCB
LOGO
FCC disclaimer

ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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TID #: TIDA-01421	Project Title: DC Motor Ripple Counter		
Number: TIDA-01421	Rev: E1	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 3	
Drawn By:	File: EVM_Hardware.SchDoc	Size: B	
Engineer: Matt Sullivan	Contact: http://www.ti.com/support		

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